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Quad Reset Supervisor with Manual Reset Input

Check for Samples: TPS386596L33

FEATURES

- 4 Voltage Monitors
- Threshold Accuracy: 0.25% (Typical)
- Fixed 50ms RESET delay time
- Active Low Manual Reset Input
- Very Low Quiescent Current: 7µA typical
- SVS-1: Fixed Threshold for monitoring 3.3V
- SVS-2/3/4 Adjustable Threshold Down to 0.4V
- Open Drain RESET Output
- Space Saving 8-pin MSOP Package

APPLICATIONS

- Notebook / Desktop Computers
- Industrial Equipment
- · Telecom, Networking Infrastructure
- · Server, Storage Equipment
- DSP and Microcontroller Applications
- FPGA/ASIC Applications

DESCRIPTION

The TPS386596L33 monitors four power rails and asserts the RESET signal when any of the SENSE inputs drop below their respective thresholds. SVS-1 can be used to monitor a 3.3V nominal power supply with no external components required. SVS-2, SVS-3, and SVS-4 are adjustable using external resistors and can be used to monitor any power supply voltage higher than 0.4V. All SENSE inputs have a threshold accuracy of 0.25% (typical). The TPS386596L33 also has an active low Manual Reset (MR) that can be used to assert the RESET signal as desired by the application. The open drain, active low RESET output de-asserts using a fixed 50ms delay.

The TPS386596L33 has a low quiescent current of 7µA typical and is available in a space saving 8-pin MSOP package.

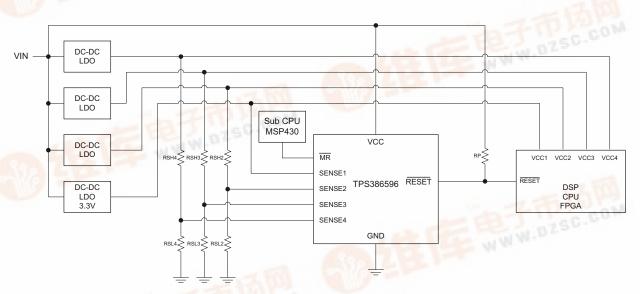


Figure 1. TPS386596L33 Typical Application Circuit



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ORDERING INFORMATION

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI Web site at www.ti.com.

Custom threshold voltages from 0.80V to 4.6V, 4.8V to 6.0V are available through the use of factory EEPROM programming. Minimum order quantities apply. Contact factory for details and availability.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) (1) (2)

	TPS386596	UNIT
Input voltage range, VCC	-0.3 to 7.0	V
Other voltage ranges: V _{MR} , V _{SENSE1} , V _{SENSE2} , V _{SENSE3} , V _{SENSE4} , V _{RESET}	-0.3 to 7.0	V
RESETpin current	5	mA
ESD rating, HBM	2	kV
ESD rating, CDM	500	V
Continuous total power dissipation	See Thermal In Table	formation
Operating virtual junction temperature range, T _J	-40 to 150	°C
Operating ambient temperature range, T _A	-40 to 125	°C
Storage temperature range, T _{stg}	-65 to 150	°C

⁽¹⁾ Stresses beyond those listed under Absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute—maximum—rated conditions for extended periods may affect device reliability.

THERMAL INFORMATION

	THERMAL METRIC ⁽¹⁾		LINUTO	
	I HERMAL METRIC	DGK (8 PINS)	UNITS	
θ_{JA}	Junction-to-ambient thermal resistance	183.8		
θ_{JCtop}	Junction-to-case (top) thermal resistance	70.7		
θ_{JB}	Junction-to-board thermal resistance	72.8	0C/M	
ΨЈТ	Junction-to-top characterization parameter	4.9	°C/W	
ΨЈВ	Junction-to-board characterization parameter	68.4		
θ_{JCbot}	Junction-to-case (bottom) thermal resistance	n/a		

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

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⁽²⁾ As a result of the low dissipated power in this device, it is assumed that $T_J = T_A$

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ELECTRICAL CHARACTERISTICS

Over the operating temperature range of $T_J = -40^{\circ}\text{C}$ to +125°C. 1.8V < VCC < 6.5V, $R_{/RESET} = 100\text{k}\Omega$ to VCC, $C_{/RESET} = 50\text{pF}$ to GND, unless otherwise noted. Typical values are at $T_J = +25^{\circ}\text{C}$.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
V_{VCC}	Input supply range		1.8		6.5	V	
	VCC Supply current (current into VCC pin)	V _{CC} = 3.3V, RESET not asserted		7	19	μΑ	
I _{VCC}		V _{CC} = 6.5V, RESET not asserted		7.5	22	μA	
	Power-up Reset Voltage (1) (2)	$V_{OL(max)} = 0.2V$, IRESET = 15 μ A			0.9	V	
\/	Negative-going Input Threshold	SENSE1	2.87	2.90	2.93	V	
V_{ITn}	Accuracy	SENSE2, SENSE3, SENSE4	396	400	404	mV	
	Hustonesia (Desitivo esias) on MT nie	SENSE1		25	72	mV	
V_{HYS}	Hysteresis (Positive-going) on VIT pin	SENSE2, SENSE3, SENSE4		3.5	10	mV	
	Input pulse width to SENSEn and $\overline{\rm MR}$ pins	SENSEn: 1.05VIT ≥ 0.95VIT		4		μs	
t _w		MR: 0.7VCC ≥ 0.3VCC		50		ns	
I _{SENSE1}	Input Current at SENSE1	VSENSE1 = 3.3V	2.2	2.75	3.3	μA	
I _{SENSEn}	Input Current at SENSEn pin, n = 2, 3, 4	VSENSEn = 0.42V	-25		25	nA	
t _d	RESETdelay time		30	50	70	ms	
V _{IL}	MR logic low input		0		0.3Vcc	V	
V _{IH}	MRlogic high input		0.7Vcc			V	
R _{MR_Pullup}	Internal pullup resistor on $\overline{\text{MR}}$ pin to VCC			100		kΩ	
		I _{OL} = 1mA			0.4	4	
V_{OL}	Low-level RESET output voltage	SENSEn = 0V, 1.3V < VCC < 1.8V, I _{OL} = 0.4mA ⁽¹⁾	0.3		V		
I _{LKG}	RESET Leakage Current	V _{RESET} = 6.5V, RESET not asserted	-300		300	nA	
C _{IN}	Input pin capacitance			5		pF	

These specs are out of recommended VCC range and only define $\overline{\text{RESET}}$ output performance during VCC ramp up. The lowest supply voltage (VCC) at which $\overline{\text{RESET}}$ becomes active. Trise(VDD) \geq 15us/V.



FUNCTIONAL BLOCK DIAGRAM

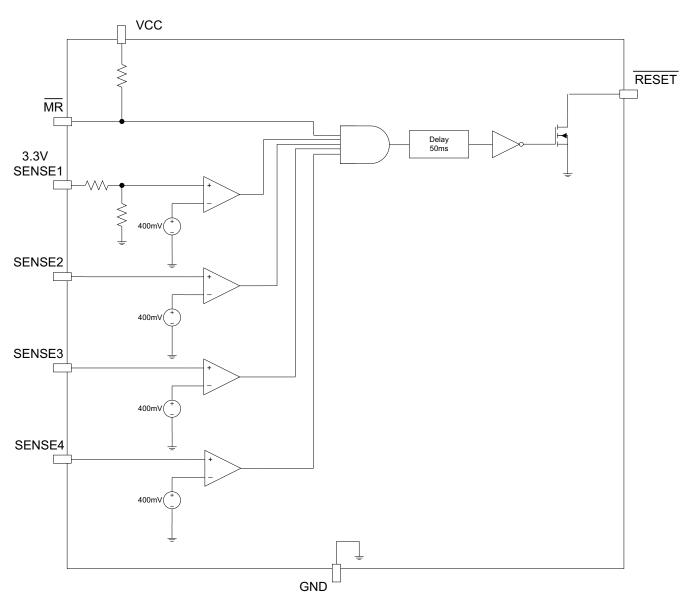
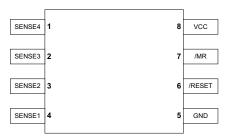


Figure 2. TPS386596L33 Block Diagram

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DEVICE INFORMATION

PIN CONFIGURATION



MSOP-8

PIN FUNCTIONS

PIN			DESCRIPTION				
NAME	NO.	DESCRIPTION					
SENSE1	4	Monitor voltage input for Supply 1	When the voltage at this terminal drops below the threshold voltage (VIT1= 2.9V), RESET is asserted.				
SENSE2	3	Monitor voltage input for Supply 2	onitor voltage input for Supply 2 When the voltage at this terminal drops below the threshold voltage (VIT2= 0.4V), RESET is asserted.				
SENSE3	2	Monitor voltage input for Supply 3 When the voltage at this terminal drops below the threshold voltage (VIT3= 0.4V), RESET is asserted.					
SENSE4	1	Monitor voltage input for Supply 4 When the voltage at this terminal drops below the threshold voltage (VIT4= 0.4V), RESET is asserted.					
MR	7	Manual reset input with internal 100k pull-up to Vcc and 50ns deglitch. Logic low level of this pin asserts RESET.					
RESET	6	RESET is an open-drain output pin. When RESET is asserted, this pin remains in a low-impedance state. When RESET is released, this pin goes to a high-impedance state after 50ms.					
Vcc	8	Supply voltage. Connecting a 0.1 µF ceramic capacitor close to this pin is recommended.					
GND	5	Ground					

GENERAL DESCRIPTION

The TPS386596L33 multi-channel reset supervisor provides a complete single reset function for a four power supply system. The design of the SVS is based on the TPS386000 quad supervisor device series. TPS386596 is designed to assert the /RESET signal following the logic in Table 1. The RESET output remains asserted for a 50ms delay time after the event of reset release. The SENSE1 input has a fixed voltage threshold designed to monitor a 3.3V nominal supply. The trip point, V_{IT1} , for SENSE1 is 2.90 (TYP). Each of the remaining SENSEn inputs (n = 2,3,4) can be set to any voltage threshold above 0.4V using an external resistor divider. An active low manual reset (MR) input is also provided for asserting the RESET signal as desired by the system.

RESET OUTPUT

In a typical application of TPS386596, the RESET output is connected to the reset input of a processor (DSP, MCU, CPU, FPGA, ASIC, etc.) or connected to the enable input of voltage regulators (DC-DC, LDO, etc.).

TPS386596 provides an open drain reset output. Pull-up resistors must be used to hold this line high when RESET is not asserted. By connecting a pull-up resistor to the proper voltage rail (up to 6.5V), the RESET output can be connected to other devices at the right interface voltage level. The pull-up resistor should be no smaller than 10kΩ as a result of the finite impedance of the output transistor.

The $\overline{\mathsf{RESET}}$ output is defined for VCC > 0.9V. To ensure that the target processor is properly reset, the VCC supply input should be fed by the power rail which is available as early as possible in the application.

Table 1 describes a truth table of how the RESET output is asserted or released. Figure 3 provides a timing diagram that shows how RESET is asserted and de-asserted in relation to MR and the SENSEn inputs. Once the conditions are met, the transitions from the asserted state to the release state are performed after a fixed 50ms delay time.

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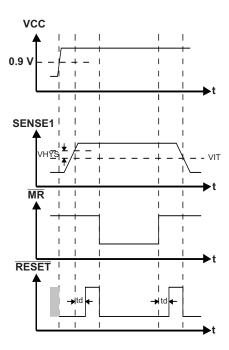


Figure 3. Timing Diagram

SENSE INPUTS

The SENSEn inputs provide terminals at which the system voltages can be monitored. If the voltage at any one of the SENSEn pins drops below their respective VITn, then the RESET output is asserted. The comparators have a built-in hysteresis to ensure smooth RESET ransitions. It is good analog design practice to use a 1nF to 10nF bypass capacitor at the SENSEn input to ground, to reduce sensitivity to transients, layout parasitics, and interference between power rails monitored by this device.

A typical connection of resistor dividers is show in Figure 4. SENSE1 is used to monitor a 3.3V nominal power supply voltage with a trip point = 2.90V, and the remaining SENSEn (n=2,3,4) inputs can be used to monitor voltage rails down to 0.4V. Threshold voltages can be calculated using the following equations.

 $VCC2_{target} = (1 + RS2H/RS2L) \times 0.4 (V)$

 $VCC3_{target} = (1 + RS3H/RS3L) \times 0.4 (V)$

 $VCC4_target = (1 + RS4H/RS4L) \times 0.4 (V)$

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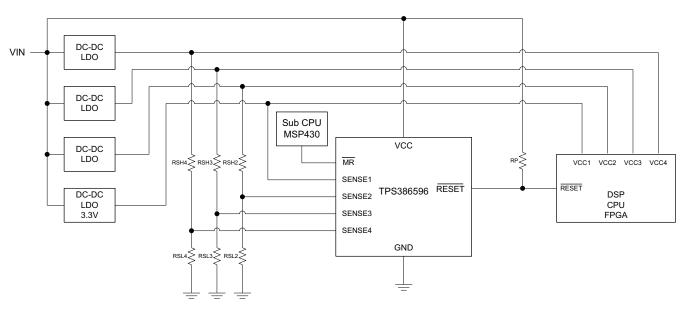


Figure 4. Typical TPS386596L33 Application Diagram

MANUAL RESET

The manual reset $\overline{\text{MR}}$ input allows external logic signal from processors, other logic circuits, and/or discrete sensors to initiate a reset. The typical application of a TPS386596 has its RESET output connected to processor. A logic low at $\overline{\text{MR}}$ causes $\overline{\text{RESET}}$ to assert. After $\overline{\text{MR}}$ returns to a logic high and SENSEn are above their respective voltage thresholds, $\overline{\text{RESET}}$ is released after a fixed 50ms reset delay time. An internal 100k Ω pull-up to V_{CC} is integrated on the $\overline{\text{MR}}$ input. There is also an internal 50ns (typical) deglitch circuit.

CONDITION **OUTPUT** $\overline{\mathsf{MR}} = \mathsf{L}$ $\overline{\mathsf{RESET}} = \mathsf{L}$ SENSEn < VITn Reset asserted $\overline{MR} = L$ SENSEn > VITn RESET = L Reset asserted $\overline{MR} = H$ RESET = L SENSE1 < VIT1 OR Reset asserted SENSE2 < VIT2 OR SENSE3 < VIT3 OR SENSE4 < VIT4 $\overline{MR} = H$ RESET = H SENSE1 > VIT1 AND Reset released SENSE2 > VIT2 AND SENSE3 > VIT3 AND SENSE4 > VIT4

Table 1. RESET Truth Table

IMMUNITY TO SENSE PIN VOLTAGE TRANSIENTS

The TPS386596 is relatively immune to short negative transients on the SENSEn pins. Sensitivity to transients is dependent on how much percentage the sense voltage drops below the threshold voltage, as shown in Figure 8. See Figure 5 for the measurement technique.

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PARAMETRIC MEASUREMENT INFORMATION

TEST CONDITION

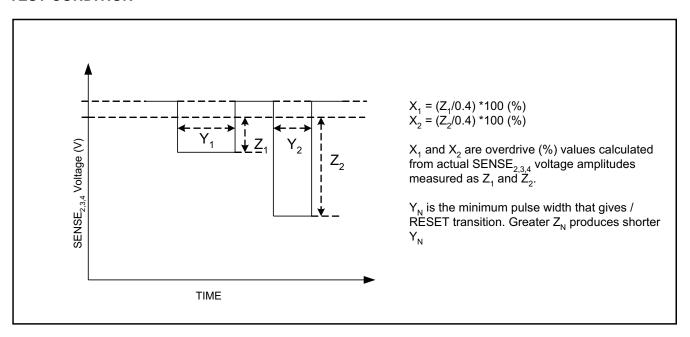
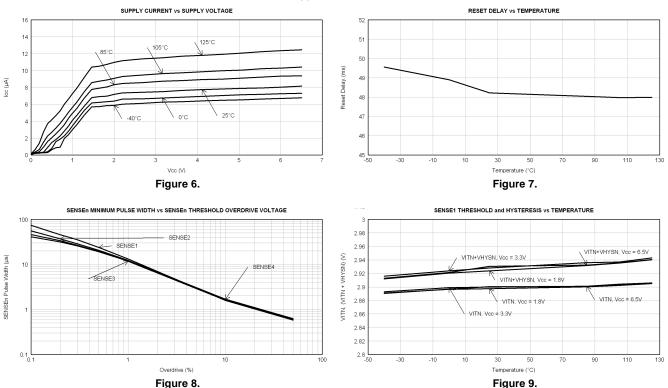


Figure 5. Measurement Technique for Immunity to Sense Pin Voltage Transient

TYPICAL CHARACTERISTICS

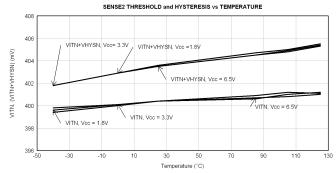
At $T_A = +25$ °C, and $V_{CC} = 3.3$ V, unless otherwise noted.



ISTRUMENTS

TYPICAL CHARACTERISTICS (continued)

At $T_A = +25$ °C, and $V_{CC} = 3.3$ V, unless otherwise noted.



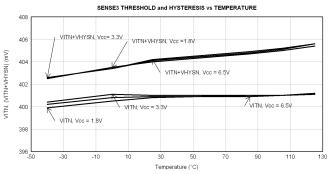
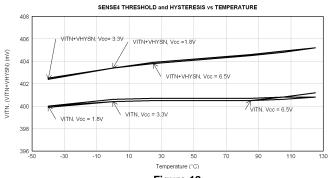


Figure 10.

Figure 11.



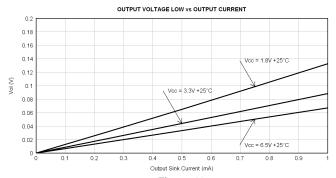
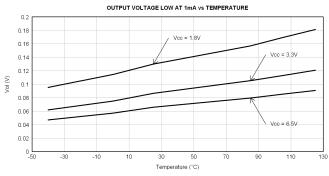


Figure 12.

Figure 13.



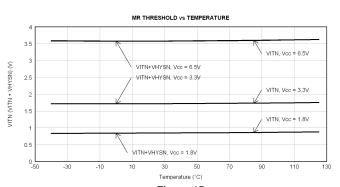
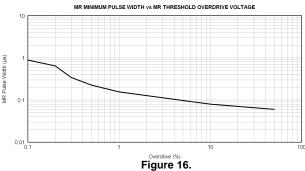


Figure 14.

Figure 15.





PACKA

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Pea
TPS386596L33DGKR	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-2600
TPS386596L33DGKT	ACTIVE	MSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-2600

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new **PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retard in homogeneous material)

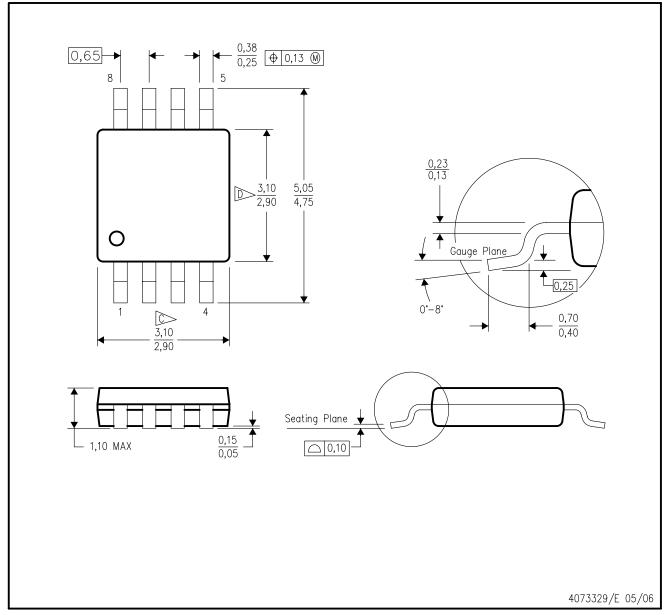
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.



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